

MCMB-1030 Series

High Current Molded Power Inductors

FEATURES

- Powder iron core material
- Magnetically shielded, low EMI
- High current carrying capacity, Low core losses
- Frequency range up to 3MHz
- Operate temperature range -40° C $\sim +125^{\circ}$ C (Including self temp. rise)
- RoHS compliant





APPLICATIONS

- Voltage Regulator Module (VRM)
- Multi-phase regulators
- Point-of-load modules
- Smart phone POL modules
- SSD modules
- Notebook regulators
- Battery power systems
- Graphics cards
- Data networking and storage systems

Explanation of Part Number

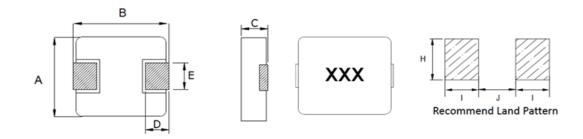
MCMB -1030 -1R0 M T

1 2 3 4 5

- → 1:Product Series:Metal Alloy Molding Power Inductor
- ♦ 2:Dimensions:
- 3: Initial inductance value: 1R0 = 1.0uH
- ♦ 4:Tolerance of Inductance:M:±20%
- ♦ 5:Packing:Tape Carrier Package



Dimensions: [mm]



Series	Α	В	С	D	E	I Тур.	Ј Тур.	Н Тур.
MCMB-1030	10.0±0.3	11.5Max	2.8±0.2	2.0±0.5	3.0±0.3	4.1	5.4	4.1

Electrical Properties:

Part Number	Inductance	DC Resistance Saturation C		n Current	Heat Rating Current	
	@100KHz,1V	Max.	Max.	Тур.	Max.	Тур.
Units	μH	mΩ	P		A	4
Symbol	L	DCR	Isat		Irms	
MCMB-1030-R22MT	0.22±20%	1.2	44.24	50.0	29.2	33.0
MCMB-1030-R33MT	0.33±20%	1.6	28.3	32.0	20.35	23.0
MCMB-1030-R36MT	0.36±20%	1.6	24.8	28.0	20.35	23.0
MCMB-1030-R47MT	0.47±20%	2.5	23.0	26.0	19.47	22.0
MCMB-1030-R82MT	0.82±20%	3.7	20.35	23.0	15.93	18.0
MCMB-1030-1R0MT	1.0±20%	6	18.58	21.0	13.27	15.0
MCMB-1030-1R5MT	1.5±20%	7.5	17.69	20.0	11.5	13.0
MCMB-1030-2R2MT	2.2±20%	9	12.38	14.0	9.73	11.0
MCMB-1030-3R3MT	3.3±20%	16	10.61	12.0	7.96	9.00
MCMB-1030-4R7MT	4.7±20%	22.5	8.84	10.0	6.19	7.00
MCMB-1030-8R2MT	8.2±20%	45	6.20	7.00	4.42	5.00
MCMB-1030-100MT	10±20%	55	5.75	6.50	3.98	4.50
MCMB-1030-330MT	33±20%	160	3.53	4.00	2.30	2.60

Notes

- ※1: All test data is referenced to 20°C ambient;
- ※2: Rated current: Isat or Irms, whichever is smaller;
- ※3: Isat(Typ): DC current at which the inductance drops approximate 30% from its value without current;
- *4: Isat(Max): DC current at which the inductance drops approximate 20% from its value without current;
- %5: Irms(Typ): DC current that causes the temperature rise (\triangle T =40°C) from 20°C ambient.
- %6: Irms(Max): DC current that causes the temperature rise ($\triangle T = 20^{\circ}C$) from 20°C ambient.
- ※7: Absolute maximum voltage 30VDC

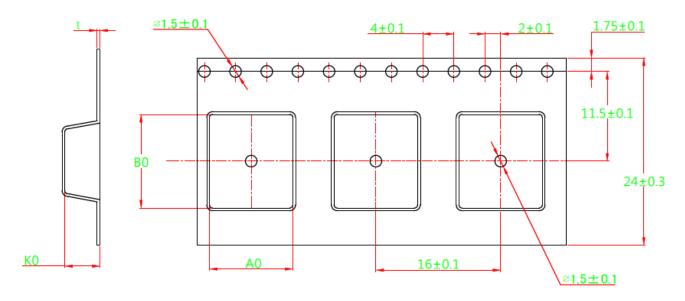


Reliability and Test Condition

Mechanical Reliability Item Specification and Deguirement Test Method					
Item	Specification and Requirement	Test Method			
	The surface of terminal immersed shall	Solder heat proof:			
Solderability	be minimum of 95% covered with a new	1. Preheating: 160 ± 10 ℃			
	coating of solder	2. Retention time: 245 ± 5 °C for 2 ± 0.5 seconds			
	Inductance change: Within ± 10% Without mechanical damage such as break	Vibration frequency:			
		(10 Hz to 55 Hz to 10Hz) in 60 seconds as a period			
Vibration		2. Vibration time:			
		Period cycled for 2 hours in each of 3 mutual			
		perpendicular directions.			
		3. Amplitude: 1.5 mm max.			
		1. Peak value: 100 G			
Shock	Inductance change: Within ±10% Without	2. Duration of pulse: 11ms			
22	mechanical damage such as break	3. 3 times in each positive and negative direction of 3			
		mutual perpendicular directions			
Endurance Reliability					
Item	Specification and Requirement	Test Method			
	Inductance change: Within ± 10% Without distinct damage in appearance	1. Repeat 100 cycles as follow:			
		(-55 ± 2 °C; 30 ± 3 min)			
Thermal		→(Room temp., 5 min)			
Shock		\rightarrow (+125 ± 2 °C, 30 ± 3 min)			
SHOCK		→ (Room temp., 5 min)			
		2. Recovery: 48 + 4 / -0 hours of recovery under the			
		standard condition after the test.			
High	Inductance change: Within ± 10%	1. Environment condition: 85 ± 2 ℃			
Temperature	Without distinct damage in appearance Inductance change: Within ± 10% Without distinct damage in appearance	Applied Current: Rated current			
Resistance		2. Duration: 1000 + 4 / -0 hours			
		1. Environment condition: 60 ± 2 ℃			
Humidity		Humidity: 90–95%			
Resistance		Applied Current: Rated current			
		2. Duration: 1000 + 4 / -0 hours			
Low	Industrial of the second Mithin 1 400/	Store temporature:			
Temperature	Inductance change: Within ± 10% Without distinct damage in appearance	Store temperature:			
Store		-55 ± 2 ℃,1000 + 4 / -0 hours			
High	Industrial Acceptance	C4 4			
Temperature	Inductance change: Within ± 10%	Store temperature:			
Store	Without distinct damage in appearance	+125 ± 2 ℃,1000 + 4 / -0 hours			

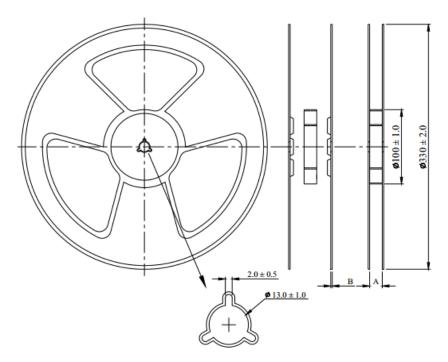


Tape Packaging Dimensions



A0	В0	K0	t
10.7 ± 0.10	12.0 ± 0.10	4.5 ± 0.1	0.35 ± 0.025

Reel Dimensions



	А	В	
mm	24.5 ± 0.2	2.0 ± 0.2	

Packaging Quantity:1000PCS/Reel



Recommended Soldering Technologies

(1)Re-flowing Profile

Preheat condition: 150 ~200 °C/60~120sec.

Allowed time above 217°C: 60~90sec.

Max temp: 260°C

Max time at max temp: 10 sec.

Solder paste: Sn/3.0Ag/0.5Cu

Allowed Reflow time: 2x max

(2)Iron Soldering Profile

Iron soldering power: Max. 30W

Pre-heating: 150°C/60sec.

Soldering Tip temperature: 350 ℃ Max.

Soldering time: 3sec. Max.

Solder paste: Sn/3.0Ag/0.5Cu

Max.1 times for iron soldering

